

Vishay Semiconductors

# SCR/SCR and SCR/Diode (MAGN-A-PAK Power Modules), 230 A



**MAGN-A-PAK** 

PRODUCT SUMMARY					
I <sub>T(AV)</sub>	230 A				

#### **FEATURES**

- · High voltage
- Electrically isolated base plate
- 3500 V<sub>RMS</sub> isolating voltage
- Industrial standard package
- · Simplified mechanical designs, rapid assembly
- · High surge capability
- Large creepage distances
- UL approved file E78996
- Compliant to RoHS directive 2002/95/EC
- Designed and qualified for industrial level

#### **DESCRIPTION**

This new VSK series of MAGN-A-PAK modules uses high voltage power thyristor/thyristor and thyristor/diode in seven basic configurations. The semiconductors are electrically isolated from the metal base, allowing common heatsinks and compact assemblies to be built. They can be interconnected to form single phase or three phase bridges or as AC-switches when modules are connected in anti-parallel mode. These modules are intended for general purpose applications such as battery chargers, welders, motor drives, UPS, etc.

MAJOR RATINGS AND CHARACTERISTICS									
SYMBOL	CHARACTERISTICS	VALUES	UNITS						
I <sub>T(AV)</sub>	85 °C	230							
I <sub>T(RMS)</sub>		510							
1	50 Hz	7500	A						
I <sub>TSM</sub>	60 Hz	7850							
l <sup>2</sup> t	50 Hz	280	1.42-						
I <b>-</b> T	60 Hz	260	- kA <sup>2</sup> s						
I <sup>2</sup> √t		280	kA²√s						
$V_{DRM}/V_{RRM}$		Up to 2000	V						
TJ	Range	- 40 to 130	°C						

### **ELECTRICAL SPECIFICATIONS**

VOLTAGE RATINGS									
TYPE NUMBER	VOLTAGE CODE	V <sub>RRM</sub> /V <sub>DRM</sub> , MAXIMUM REPETITIVE PEAK REVERSE AND OFF-STATE BLOCKING VOLTAGE V	V <sub>RSM</sub> , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE V	I <sub>RRM</sub> /I <sub>DRM</sub> AT 130 °C MAXIMUM mA					
	08	800	900						
	12	1200	1300						
VSK.230-	16	1600	1700	50					
	18	1800	1900						
	20	2000	2100						

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## VSK.230..PbF Series

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PARAMETER	SYMBOL		TEST CONDITION	VALUES	UNITS	
Maximum average on-state current	I <sub>T(AV)</sub>	180° conduction	n, half sine wave	230	A	
at case temperature					85	°C
Maximum RMS on-state current	I <sub>T(RMS)</sub>	As AC switch			510	
		t = 10 ms	No voltage		7500	
Maximum peak, one-cycle on-state		t = 8.3 ms	reapplied		7850	Α
non-repetitive, surge current	I <sub>TSM</sub>	t = 10 ms	100 % V <sub>RRM</sub>	Sinusoidal	6300	
		t = 8.3 ms	reapplied	half wave,	6600	
		t = 10 ms	No voltage	initial T <sub>J</sub> =	280	kA <sup>2</sup> s
Maximum I <sup>2</sup> t for fusing	l <sup>2</sup> t	t = 8.3 ms	reapplied	T <sub>J</sub> maximum	256	
		t = 10 ms	100 % V <sub>RRM</sub>		198	
		t = 8.3 ms	reapplied		181	
Maximum I <sup>2</sup> √t for fusing	I²√t	t = 0.1 ms to 10	ms, no voltage re	applied	2800	kA²√s
Low level value or threshold voltage	V <sub>T(TO)1</sub>	(16.7 % x $\pi$ x $I_{T_0}$ $T_J = T_J$ maximur	$A(V) < I < \pi \times I_{T(A(V))},$		1.03	V
High level value of threshold voltage	V <sub>T(TO)2</sub>	$(I > \pi \times I_{T(AV)} < I < I)$	$< \pi \times I_{T(AV)}$ ), $T_J = T$	J maximum	1.07	
Low level value on-state slope resistance	r <sub>t1</sub>	(16.7 % x $\pi$ x $I_{T_0}$ $I_J = I_J$ maximur	$A_{\text{AV}} < I < \pi \times I_{\text{T(AV)}},$		0.77	0
High level value on-state slope resistance	r <sub>t2</sub>	$(I > \pi \times I_{T(AV)} < I$	$< \pi \times I_{T(AV)}$ , $T_J = T$	0.73	mΩ	
Maximum on-state voltage drop	V <sub>TM</sub>	$I_{TM} = \pi \times I_{T(AV)}$ , $T_J = T_J$ maximum, 180° conduction, average power = $V_{T(TO)} \times I_{T(AV)} + r_f \times (I_{T(RMS)})^2$			1.59	V
Maximum holding current	I <sub>H</sub>	Anode supply =	12 V, initial $I_T = 3$	0 A, T <sub>J</sub> = 25 °C	500	
Maximum latching current	ΙL	,	12 V, resistive loa , 100 μs, T <sub>J</sub> = 25	•	1000	mA

SWITCHING								
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS				
Typical delay time	t <sub>d</sub>	T <sub>J</sub> = 25 °C, gate current = 1 A dl <sub>g</sub> /dt = 1 A/μs	1.0					
Typical rise time	t <sub>r</sub>	$V_{d} = 0.67 \% V_{DRM}$	2.0	μs				
Typical turn-off time	t <sub>q</sub>	$I_{TM}$ = 300 A; dI/dt = 15 A/μs; $T_J$ = $T_J$ maximum; $V_R$ = 50 V; dV/dt = 20 V/μs; gate 0 V, 100 $\Omega$	50 to 150	μO				

BLOCKING									
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS					
Maximum peak reverse and off-state leakage current	I <sub>RRM,</sub> I <sub>DRM</sub>	$T_J = T_J$ maximum	50	mA					
RMS insulation voltage	$V_{INS}$	50 Hz, circuit to base, all terminals shorted, 25 °C, 1 s		V					
Critical rate of rise of off-state voltage	dV/dt	$T_J = T_J$ maximum, exponential to 67 % rated $V_{DRM}$	1000	V/µs					



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TRIGGERING					
PARAMETER	SYMBOL	TEST C	CONDITIONS	VALUES	UNITS
Maximum peak gate power	P <sub>GM</sub>	$t_p \le 5 \text{ ms}, T_J = T_J r$	maximum	10.0	W
Maximum average gate power	P <sub>G(AV)</sub>	$f = 50 \text{ Hz}, T_J = T_J \text{ r}$	maximum	2.0	, vv
Maximum peak gate current	+ I <sub>GM</sub>	$t_p \le 5 \text{ ms}, T_J = T_J r$	maximum	3.0	А
Maximum peak negative gate voltage	- V <sub>GT</sub>	$t_p \le 5 \text{ ms}, T_J = T_J \text{ maximum}$		5.0	
	V <sub>GT</sub>	T <sub>J</sub> = - 40 °C	Anode supply = 12 V, resistive load; Ra = 1 $\Omega$	4.0	V
Maximum required DC gate voltage to trigger		T <sub>J</sub> = 25 °C		3.0	
		T <sub>J</sub> = T <sub>J</sub> maximum	100001100 1000, 110 - 1 32	2.0	
		T <sub>J</sub> = - 40 °C		350	
Maximum required DC gate current to trigger	I <sub>GT</sub>	T <sub>J</sub> = 25 °C	Anode supply = 12 V, resistive load; Ra = 1 $\Omega$	200	mA
		T <sub>J</sub> = T <sub>J</sub> maximum	1031311VC 1040, 114 - 1 32	100	
Maximum gate voltage that will not trigger	$V_{GD}$	$T_J = T_J$ maximum, rated $V_{DRM}$ applied		0.25	V
Maximum gate current that willnot trigger	I <sub>GD</sub>	$T_J = T_J$ maximum, rated $V_{DRM}$ applied		10.0	mA
Maximum rate of rise of turned-on current	dl/dt	$T_J = T_J$ maximum, $I_{TM} = 400$ A, rated $V_{DRM}$ applied		500	A/µs

THERMAL AND MECHANICAL SPECIFICATIONS							
PARAMETER		SYMBOL	SYMBOL TEST CONDITIONS		UNITS		
Junction operating temper	rature range	TJ		- 40 to 130	°C		
Storage temperature range	е	T <sub>Stg</sub>		- 40 to 150	1 30		
Maximum thermal resistance, junction to case per junction		R <sub>thJC</sub>	DC operation	0.125	12.004		
Typical thermal resistance, case to heatsink per module		R <sub>thCS</sub>	Mounting surface flat, smooth and greased	0.02	K/W		
Mounting torque ± 10 %	MAP to heatsink		A mounting compound is recommended and the torque should be rechecked after a	4 to 6	Nm		
busbar to MAP			period of about 3 h to allow for the spread of the compound.	4 10 0	INIII		
Approximate weight				500	g		
				17.8	oz.		
Case style				MAGN-	-A-PAK		

△R CONDUCTION PER JUNCTION											
DEVICES	SINUSOIDAL CONDUCTION AT T <sub>J</sub> MAXIMUM RECTANGULAR CONDUCTION AT T <sub>J</sub> MAXIMUM									UNITS	
DEVICES	180°	120°	90°	60°	30°	180°	120°	90°	60°	30°	UNITS
VSK.230-	0.009	0.010	0.010	0.020	0.032	0.007	0.011	0.015	0.020	0.033	K/W

#### Note

Table shows the increment of thermal resistance R<sub>thJC</sub> when devices operate at different conduction angles than DC

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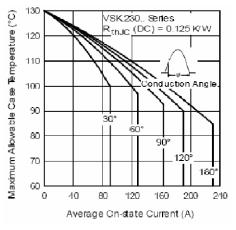


Fig. 1 - Current Ratings Characteristics

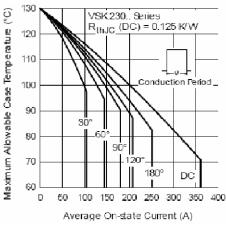


Fig. 2 - Current Ratings Characteristics

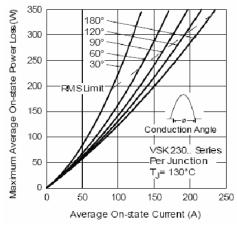


Fig. 3 - On-State Power Loss Characteristics

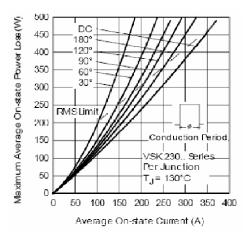


Fig. 4 - On-State Power Loss Characteristics

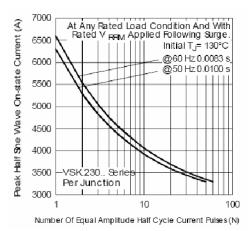


Fig. 5 - Maximum Non-Repetitive Surge Current

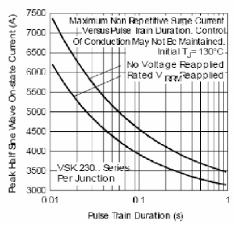


Fig. 6 - Maximum Non-Repetitive Surge Current



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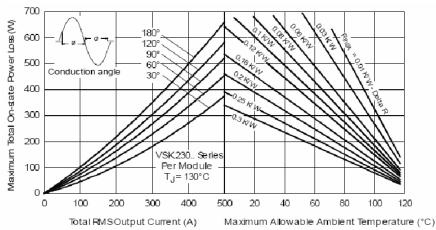


Fig. 7 - On-State Power Loss Characteristics

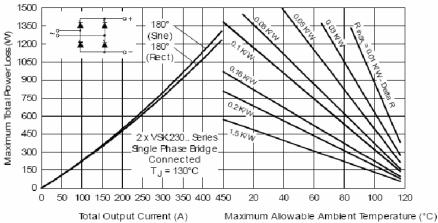


Fig. 8 - On-State Power Loss Characteristics

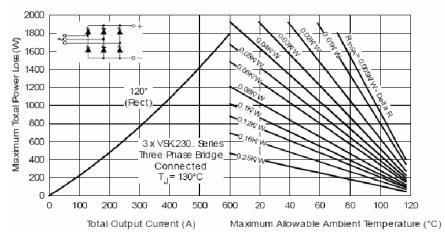


Fig. 9 - On-State Power Loss Characteristics

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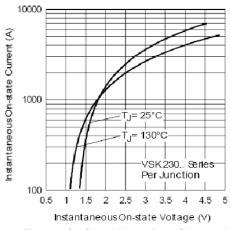


Fig. 10 - On-State Voltage Drop Characteristics

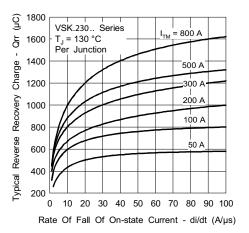


Fig. 11 - Reverse Recovery Charge Characteristics

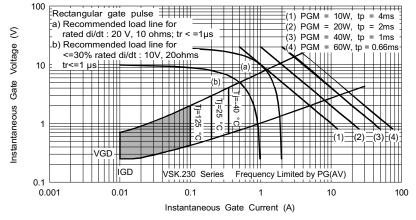


Fig. 12 - Gate Characteristics

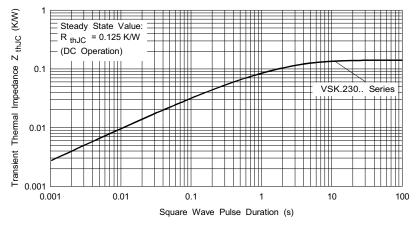


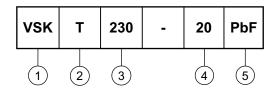
Fig. 13 - Thermal Impedance Z<sub>thJC</sub> Characteristics



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### **ORDERING INFORMATION TABLE**

#### **Device code**

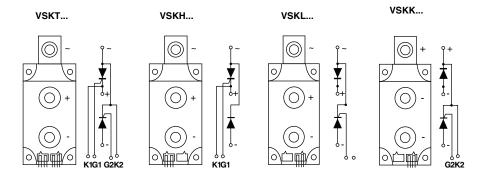


- 1 Module type
- 2 Circuit configuration (see dimensions link at the end of datasheet)
- 3 Current rating
- Voltage code x 100 = V<sub>RRM</sub> (see Voltage Ratings table)
- 5 • None = Standard production
  - PbF = Lead (Pb)-free

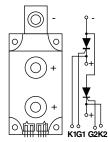
#### Note

• To order the optional hardware go to <a href="https://www.vishay.com/doc?95172">www.vishay.com/doc?95172</a>

### **CIRCUIT CONFIGURATION**



vskv...



Available 800 V; contact factory for different requirements.

LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95086			



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